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Process Change Notification

Date: Wednesday, June 17, 2015

PCR Reference: 572

PCN Reference: 572-PCN90-Public

To Our Value Customer:

As always we appreciate your use of International Rectifier semiconductor products. Our commitment to customer satisfaction and continuous improvement is demonstrated by our change plans to enhance capacity, quality and reliability. This notice is to inform you of the following changes.

We would like to express our sincere appreciation for your cooperation regarding the following changes, and IR will work closely with you to support your requirements during this transition.

Type of Change Notification:

Additional assembly site for DPak IGBT Copak products

Description of Change:

Energy Saving Products- DPak IGBT Copak

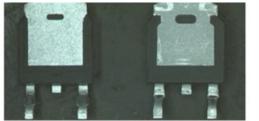
GEM Shanghai (China) will be the alternate assembly sites for the part numbers identified in the following page. As a result of this change, the package will change as follows:

Bill of Materials

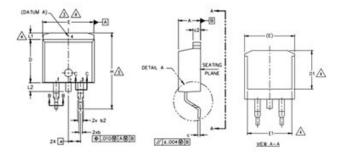
ITEM	EXISTING	TARGET
Assembly site	International Rectifier Mexico	GEM Shanghai
Mold compound	No change	78 mm - 197 mm - 197 mm - 198
Die attach solder	Pb/In/Ag	Pb/Sn/Ag
Leadframe	Selective Ni, dual gauge	Bare Cu, single gauge
Lead plating	No change	

FRONT VIEW		REA	REAR VIEW		
EXISTING	TARGET	EXISTING	TARGET		
		Err Comment			

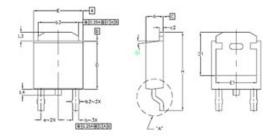




EXISTING



TARGET



3L DPAK (TO-252) PACKAGE OUTLINE COMPARISON

		JEDEC		IR		GEM (Proposed site)		
			INCH		NCH		INCH	
SYMBOL	SYMBOL DESCRIPTION	MIN	MAX	MIN	MAX	MIN	MAX	
A	Package thickness	.086	.094	.086	.094	.087	.094	
A1	Heatsink to leads coplananty	-	.005	-	.005	-	.005	
b	Leadwidth(with plating)	.025	.035	.025	.035	.025	.035	
b2	Standoff width(with plating)	.030	.045	.030	.045	.030	045	
b3	Heat sink width	.195	.215	.195	.215	205	.215	
С	Lead thickness(with plating)	.018	.024	.018	.024	.018	.024	
c2	Heatsink thickness	.018	.035	.018	.035	.018	.023	
D	Package length	.235	.245	.235	.245	.236	.245	
D1	Thermal pad length	.205	-	.205	-	.205	-	
E	Package width	.250	.265	.250	.265	.252	.265	
E1	Thermal pad width	.170	-	.170		.173	-	
e	Lead pitch	.090 BSC		.090 BSC		.090 BSC		
Н	Overall length	.370	.410	.370	.410	.370	.409	
L	Lead length-solderable	.055	.070	.055	.070	.055	.070	
L1	Total lead length	.108 REF		.108 REF		.108 REF		
L2	Reference for dim L	.020 BSC		.020 BSC		.020 BSC		
L3	Top of heat sink to mold package	.035	.050	.035	.050	.035	.050	
L4	Middle Lead Length	-	.040	-	.040	.025	.040	

Reason for the Change:

Additional assembly capacity and Bill of Materials consolidation.

Effect Date:

Tuesday, September 15, 2015

International Rectifier will consider this change approved and will implement it by the effective date unless specific conditions of acceptance or data requests are provided in writing within 30 days of receipt of this notice. Please submit conditions of acceptance and data requests to the PCN coordinator listed at the end of this notice.

Impact of Change:

No impact is expected for typical applications. The new assembly site will meet the same qualification level as the existing products. Datasheet will not be modified as the result of this change in assembly site and bill of materials.

Method of Identifying Changed Product:

See visuals in description

Products Affected:

IR Part	Description
IRGR2B60KDPBF	
IRGR2B60KDTRLPBF	
IRGR4045DPBF	600V, 6A, COPAK-DPAK
IRGR4045DTRLPBF	
IRGR4045DTRPBF	
IRGR4607DPBF	
IRGR4610DPBF	
IRGR4610DTRPBF	

Qualification:

Parts passed all the reliability testing requirements. Reliability qualification report is available upon request. Qualification standards can be found on International Rectifier's web site at www.irf.com/product-info/reliability

Supporting Data Availability:

Contact IR for supporting data on this change.

Contact Information:

CONTACT TYPE	NAME	PHONE	EMAIL
PCN Coordinator	Mark Ogden		mogden1@irf.com
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